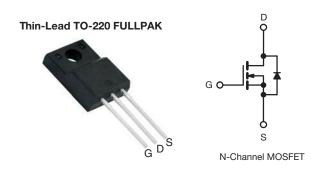
COMPLIANT

HALOGEN

**FREE** 

Vishay Siliconix

# **E Series Power MOSFET**



PRODUCT SUMMARY		
V <sub>DS</sub> (V) at T <sub>J</sub> max.	70	00
R <sub>DS(on)</sub> max. (Ω) at 25 °C	$V_{GS} = 10 \text{ V}$	0.6
Q <sub>g</sub> max. (nC)	4	8
Q <sub>gs</sub> (nC)	6	6
Q <sub>gd</sub> (nC)	1	1
Configuration	Sin	gle

#### **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>a</sub>)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free	SiHA6N65E-E3
Lead (Pb)-free and halogen-free	SiHA6N65E-GE3

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	650	V	
Gate-source voltage			$V_{GS}$	± 30		
Continuous drain current (T <sub>J</sub> = 150 °C) <sup>e</sup>	V at 10 V	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$	I <sub>D</sub>	7		
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		5	Α	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	18		
Linear derating factor				0.63	W/°C	
Single pulse avalanche energy b			E <sub>AS</sub>	56	mJ	
Maximum power dissipation	$P_{D}$	31	W			
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	T <sub>J</sub> = 125 °C		dV/dt	37	V/ns	
Reverse diode dV/dt <sup>d</sup>			αν/αι	27	V/IIS	
Soldering recommendations (peak temperature) c	For 10 s			300	°C	
Mounting torque	M3 s	screw		0.6	Nm	

#### **Notes**

- a. Repetitive rating; pulse width limited by maximum junction temperature b.  $V_{DD}=50$  V, starting  $T_J=25$  °C, L=28.2 mH,  $R_g=25$   $\Omega$ ,  $I_{AS}=2$  A c. 1.6 mm from case

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- d.  $I_{SD} \le I_{D}$ , dI/dt = 100 A/ $\mu$ s, starting  $T_{J} = 25$  °C e. Limited by maximum junction temperature

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THERMAL RESISTANCE RAT	INGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R <sub>thJA</sub>	43	65	°C/W
Maximum junction-to-case (drain)	R <sub>thJC</sub>	3.1	4.0	G/ VV

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		650	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.73	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2	-	4	V
		V <sub>GS</sub> = ± 20 V		-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
		V <sub>DS</sub> = 650 V, V <sub>GS</sub> = 0 V		-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 520 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 3 A	-	0.5	0.6	Ω
Forward transconductance	9fs	$V_{DS}$	= 30 V, I <sub>D</sub> = 3 A	-	2	-	S
Dynamic		*		*		•	•
Input capacitance	C <sub>iss</sub>	V		410	820	1640	pF
Output capacitance	C <sub>oss</sub>	,	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$		40	80	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1 MHz		2	4	8	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>			-	36	-	
Effective output capacitance, time related <sup>b</sup>	$C_{o(tr)}$	$V_{DS} = 0$	$V_{DS} = 0 \text{ V to } 520 \text{ V}, V_{GS} = 0 \text{ V}$		117	-	
Total gate charge	Qg			-	24	48	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 3 A, V_{DS} = 520 V$	-	6	-	nC
Gate-drain charge	Q <sub>gd</sub>			-	11	-	
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = 520 V, I <sub>D</sub> = 3 A,		-	14	28	
Rise time	t <sub>r</sub>			-	12	24	
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub> =	$= 10 \text{ V}, R_g = 9.1 \Omega$	-	30	60	ns
Fall time	t <sub>f</sub>	1		-	20	40	1
Gate input resistance	$R_g$	f = 1 MHz, open drain		0.4	1.4	2.7	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	7	
Pulsed diode forward current	I <sub>SM</sub>			-	-	18	- A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 3 A, V <sub>GS</sub> = 0 V		-	0.83	1.3	V
Reverse recovery time	t <sub>rr</sub>	-		118	237	474	ns
Reverse recovery charge	Q <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 3 \text{A},$ $dI/dt = 100 \text{A/}\mu\text{s}, V_R = 25 \text{V}$		-	2.2	-	μC
Reverse recovery current	I <sub>RRM</sub>			_	16	_	A

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$  b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

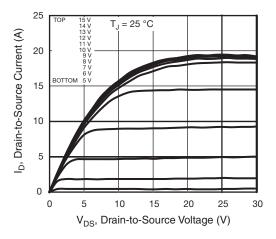


Fig. 1 - Typical Output Characteristics

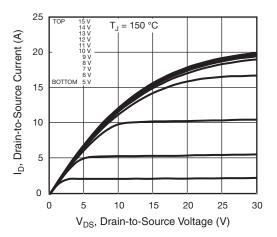


Fig. 2 - Typical Output Characteristics

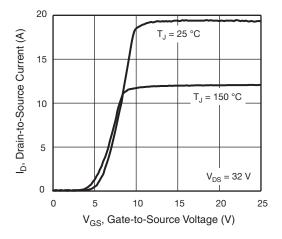


Fig. 3 - Typical Transfer Characteristics

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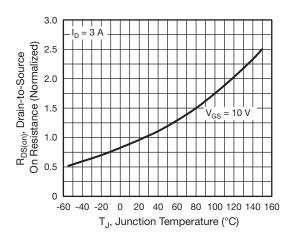


Fig. 4 - Normalized On-Resistance vs. Temperature

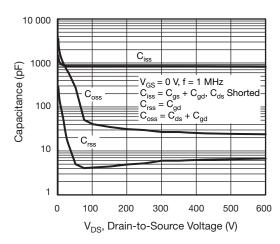


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

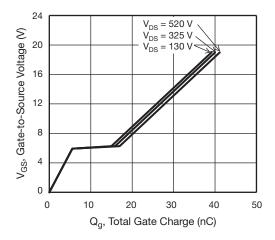


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



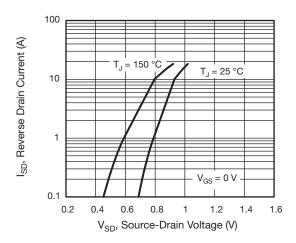


Fig. 7 - Typical Source-Drain Diode Forward Voltage

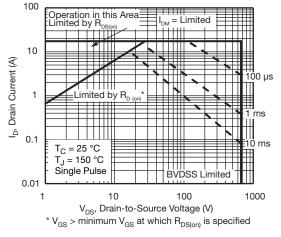


Fig. 8 - Maximum Safe Operating Area

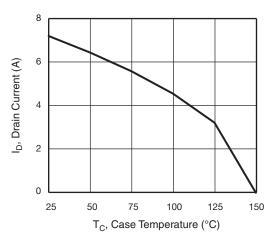


Fig. 9 - Maximum Drain Current vs. Case Temperature

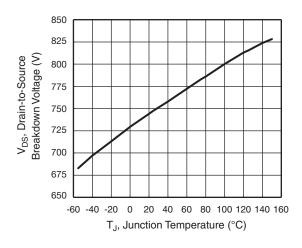


Fig. 10 - Temperature vs. Drain-to-Source Voltage

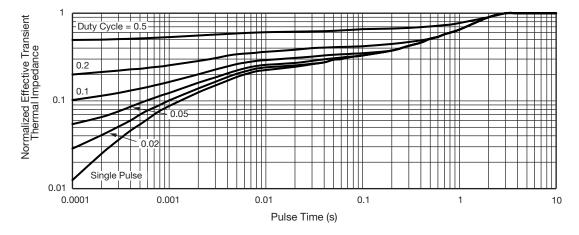


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



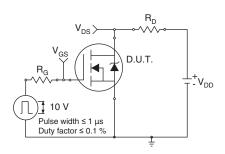


Fig. 12 - Switching Time Test Circuit

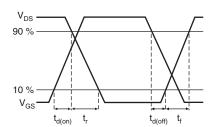


Fig. 13 - Switching Time Waveforms

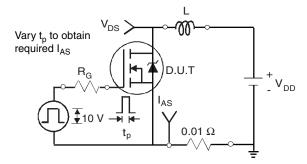


Fig. 14 - Unclamped Inductive Test Circuit

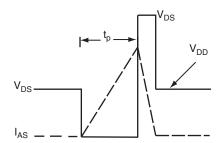


Fig. 15 - Unclamped Inductive Waveforms

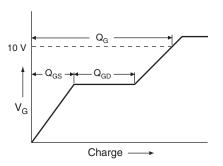


Fig. 16 - Basic Gate Charge Waveform

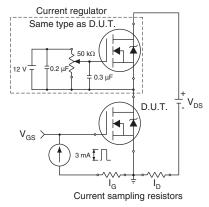
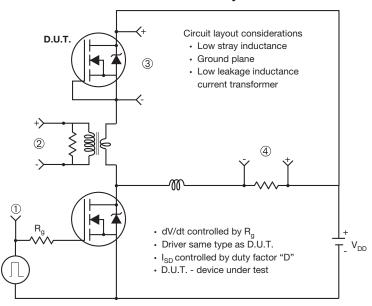


Fig. 17 - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



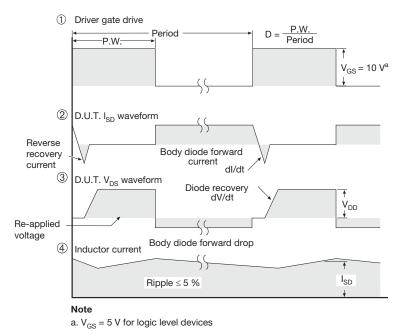
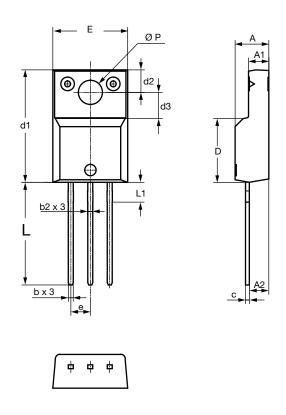


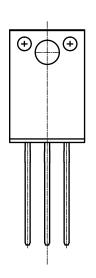
Fig. 18 - For N-Channel

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# **TO-220 FULLPAK Thin Lead**





SYMBOL		DIMEN	ISIONS		
	MILLIN	IETERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.30	4.70	0.169	0.185	
A1	2.50	2.90	0.098	0.114	
A2	2.40	2.80	0.094	0.110	
b	0.60	0.80	0.024	0.031	
b2	0.60	0.90	0.024	0.035	
С	=	0.60	-	0.024	
D	8.30	8.70	0.327	0.342	
d1	14.70	15.30	0.579	0.602	
d2	2.90	3.10	0.114	0.122	
d3	3.30	3.70	0.130	0.146	
Е	9.70	10.30	0.382	0.406	
е	2.50	2.70	0.098	0.106	
L	13.40	13.80	0.528	0.543	
L1	1.00	2.80	0.039	0.110	
ØP	3.00	3.40	0.118	0.134	

ECN: E20-0684-Rev. D, 28-Dec-2020

DWG: 6021



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